

## Features

- Guard Ring Die Construction for Transient Protection
- Low Power Loss, High Efficiency
- Patented Interlocking Clip Design for High Surge Current Capacity
- High Current Capability and Low Forward Voltage Drop
- Lead-Free Finish; RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- An Automotive-Compliant Part is Available Under Separate Datasheet (<u>DFLS120LQ</u>)

### **Mechanical Data**

- Package: PowerDI<sup>®</sup>123
- Package Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminal Connections: Cathode Band
- Terminals: Finish Matte Tin Annealed over Copper Leadframe. Solderable per MIL-STD-202, Method 208 (@3)
- Weight: 0.01 grams (Approximate)
- PowerDI123



Top View

## Ordering Information (Note 4)

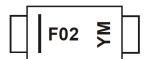
Part Number	Packago	Packing		
Fait Nulliber	Package	Qty.	Carrier	
DFLS120L-7	PowerDI123	3000	Tape & Reel	

 EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant. All applicable RoHS exemptions applied.
See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.

3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.</p>

4. For packaging details, go to our website at https://www.diodes.com/design/support/packaging/diodes-packaging/.

## Marking Information



F02 = Product Type Marking Code YM = Date Code Marking Y = Year (ex: J = 2022) M = Month (ex: 9 = September)



Date Code Key

Notes:

Year	2004		2022	2023	2024	2025	2026	2027	2028	2029	2030	2031
Code	R		J	К	L	М	Ν	0	Р	R	S	Т
Month	Jan	Feb	Mar	Apr	Мау	Jun	Jul	Aug	Sep	Oct	Nov	Dec



### Maximum Ratings (@T<sub>A</sub> = +25°C, unless otherwise specified.)

Single phase, half wave, 60Hz, resistive or inductive load. For capacitive load, derate current by 20%.

Characteristic	Symbol	Value	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	Vrrm Vrwm Vr	20	V
RMS Reverse Voltage	VR(RMS)	14	V
Average Forward Current	IF(AV)	1.0	А
Non-Repetitive Peak Forward Surge Current 8.3ms Single Half Sine-Wave Superimposed on Rated Load	IFSM	50	А

# **Thermal Characteristics**

Characteristic	Symbol	Value	Unit
Power Dissipation (Note 5)	PD	1.67	W
Power Dissipation (Note 6)	PD	556	mW
Thermal Resistance Junction to Ambient (Note 5)	Reja	60	°C/W
Thermal Resistance Junction to Ambient (Note 6)	Reja	180	°C/W
Thermal Resistance Junction to Soldering (Note 7)	Rejs	10	°C/W
Operating Temperature Range	TJ	-55 to +125	°C
Storage Temperature Range	T <sub>STG</sub>	-55 to +150	°C

#### Electrical Characteristics (@T<sub>A</sub> = +25°C, unless otherwise specified.)

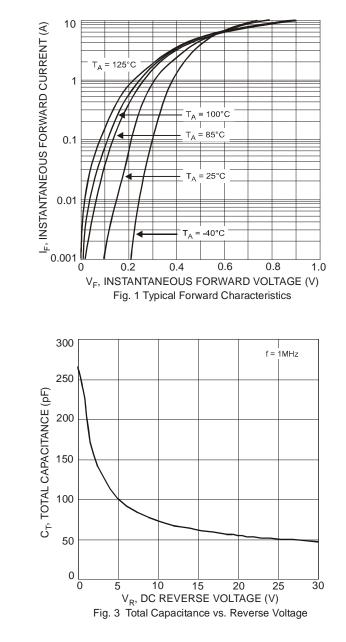
Characteristic	Symbol	Min	Тур	Мах	Unit	Test Condition
Reverse Breakdown Voltage (Note 8)	V <sub>(BR)R</sub>	20		_	V	I <sub>R</sub> = 1.0mA
Forward Voltage	VF		0.20 0.30 0.32	 0.36	V	IF = 0.1A IF = 0.7A IF = 1.0A
Leakage Current (Note 8)	IR		0.26	 1.0	mA	V <sub>R</sub> = 5V, T <sub>A</sub> = +25°C V <sub>R</sub> = 20V, T <sub>A</sub> = +25°C
Total Capacitance	Ст		75		pF	V <sub>R</sub> = 10V, f = 1.0MHz

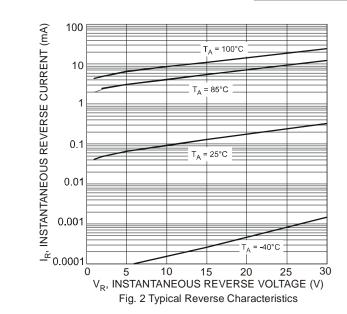
Notes: 5. Part mounted on 50.8mm x 50.8mm GETEK board with 25.4mm x 25.4mm copper pad, 25% anode, 75% cathode. T<sub>A</sub> = +25°C.

6. Part mounted on FR-4 board with 1.8mm x 2.5mm cathode and 1.8mm x 1.2mm anode, 1 oz. copper pads.  $T_A = +25^{\circ}C$ . 7. Theoretical  $R_{BJS}$  calculated from the top center of the die straight down to the PCB/cathode tab solder junction.

8. Short duration pulse test used to minimize self-heating effect.





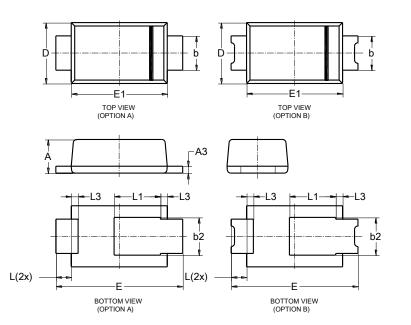




## **Package Outline Dimensions**

Please see http://www.diodes.com/package-outlines.html for the latest version.



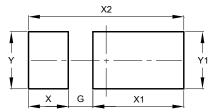


[		<b>B</b> 1400					
PowerDI123							
Dim	Min	Max	Тур				
Α	0.93	1.00	0.98				
A3	0.15	0.25	0.20				
b	0.85	1.25	1.00				
b2	1.025	1.125	1.10				
D	1.63	1.93	1.78				
E	3.50	3.90	3.70				
E1	2.60	3.00	2.80				
L	0.40	0.50	0.45				
L1	1.25	1.40	1.35				
L3	0.125	0.275	0.20				
All Dimensions in mm							

# **Suggested Pad Layout**

Please see http://www.diodes.com/package-outlines.html for the latest version.

PowerDI123



Dimensions	Value		
Dimensions	(in mm)		
G	0.65		
Х	1.05		
X1	2.40		
X2	4.10		
Y	1.50		
Y1	1.50		



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